



DIAMETER PLATED QUANTITY SYMBOL

PAD	-	778	-
10MIL	YES	153	A
18MIL	YES	235	B
40MIL	YES	59	C

SMALLEST TRACE/SPACE 5MIL/4MIL  
 TOP FINISH PLATED WITH SOFT WIRE BONDABLE GOLD OVER NICKEL  
 SOLDER MASK CLEAR (IF POSSIBLE) / SILK SCREEN WHITE  
 MATERIAL 1MIL THICK KAPTON / TWO SIDES COATED  
 WITH 1/20Z COPPER PER SQUARE FOOT

NOTE:

- 1) ON BOTTOM SIDE OF THIS HYBRID GLUE 1/2MIL KAPTON FOR ELECTRICAL ISOLATION. GERBER FILE FOR THIS PART IS INCLUDED IN THIS DOCUMENTATION PACKAGE.
- 2) THEN THIS KAPTON HYBRID BOARD BOND WITH EPOXY ON CARBON/CARBON BOARD (WITH DIMENSIONS 250MM x 6.3MM x 0.75MM) SO THAT TOP LEFT CORNER OF KAPTON HYBRID COINCIDE WITH TOP LEFT CORNER OF THE CARBON/CARBON BOARD (CARBON/CARBON BOARD WILL BE SUPPLY BY MIT)
- 3) IN CONNECTOR REGION ADD FROM BOTTOM SIDE FR4/G10 35MIL THICK BOARD FOR KAPTON STIFFING. GERBER FILE FOR THIS FR4/G10 BOARD IS ALSO INCLUDED IN THIS DOCUMENTATION.